

## STV200N55F3

# N-channel 55 V, 1.8 mΩ, 200 A, PowerSO-10 STripFET™ Power MOSFET

#### **Features**

Туре	V <sub>DSS</sub>	R <sub>DS(on)</sub> max	I <sub>D</sub> <sup>(1)</sup>
STV200N55F3	55 V	$<$ 2.5 m $\Omega$	200 A

- 1. Current limited by package
- Conduction losses reduced
- Low profile, very low parasitic inductance

#### **Application**

■ Switching applications

#### **Description**

This n-channel enhancement mode Power MOSFET is the latest refinement of ST's STripFET™ process. The resulting transistor shows extremely high packing density for low on resistance, rugged avalanche characteristics and low gate charge.

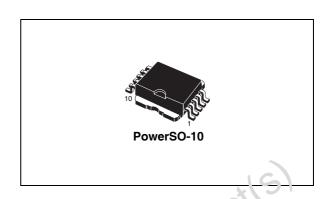
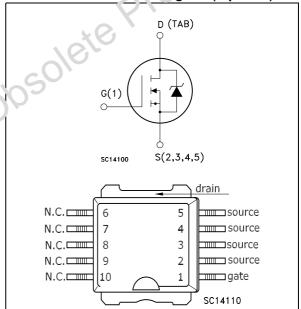


Figure 1. Internal schematic diagram and connection diagram (top view)



fable 1. Device summary

Order code	Marking	Package	Packaging
STV200N55F3	200N55F3	PowerSO-10	Tape and reel

Contents STV200N55F3

#### **Contents**

1	Electrical ratings
2	Electrical characteristics
3	Test circuits
4	Package mechanical data
5	Revision history
Obsol	Revision history 11  Obsolete Product(s)  ate Product(s)

2/12

STV200N55F3 **Electrical ratings** 

#### **Electrical ratings** 1

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage (v <sub>gs</sub> = 0)	55	V
V <sub>GS</sub>	Gate-source voltage	± 20	V
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>C</sub> = 25 °C	200	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	170	Α
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	800	Α
P <sub>TOT</sub> (3)	Total dissipation at T <sub>C</sub> = 25 °C	300	W
	Derating factor	2.0	W/°C
E <sub>AS</sub> (4)	Single pulse avalanche energy	1.0	J
T <sub>stg</sub>	Storage temperature	55 to 175	°C
T <sub>j</sub>	Operating junction temperature -55 to 175		

- 1. Current limited by package
- 2. Pulse width limited by safe operating area
- 3. This value is rated according to Rthj-c
- 4. Starting Tj = 25 °C,  $I_D$  = 60 A,  $V_{DD}$  = 35 V

Table 3. Thermal data

Tj	Operating junction temperature					
Current limited by package						
Pulse width limited by safe operating area						
3. This value	3. This value is rated according to Rthj-c					
4. Starting Tj = 25 °C, $I_D$ = 60 A, $V_{DD}$ = 35 V						
	1610					
Table 3.	Table 3. Thermal data					
Symbol Parameter Value U		Unit				
Rthj-case	Thermal resistance junction-case max	0.5	°C/W			
Rthj-pcb <sup>(1)</sup>	Thermal resistance junction-pcb max	50	°C/W			

on 1 inc 1. When mounted on 1 inch<sup>2</sup> FR-4 2 oz Cu Electrical characteristics STV200N55F3

## 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Table 4. On /off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \mu A, V_{GS} = 0$	55			V
I <sub>DSS</sub>	Zero gate voltage drain current (V <sub>GS</sub> = 0)	$V_{DS}$ = Max rating, $V_{DS}$ = Max rating, $T_c$ = 125 °C			1 10	μ <b>Α</b> μ <b>Α</b>
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>DS</sub> = ± 20 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R <sub>DS(on)</sub>	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 75 \text{ A}$		1.8	2.5	mΩ

Table 5. Dynamic

Table 6. **Switching times** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub> t <sub>r</sub>	Turn-on delay time Rise time	$V_{DD} = 27.5 \text{ V}, I_{D} = 60 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V},$ Figure 13		25 150		ns ns
t <sub>d(off)</sub> t <sub>f</sub>	Turn-off delay time Fall time	$V_{DD} = 27.5 \text{ V}, I_{D} = 60 \text{ A}$ $R_{G} = 4.7 \Omega, V_{GS} = 10 \text{ V},$ Figure 13		110 50		ns ns

Table 7. Source drain diode

	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current				200	A
I <sub>SD</sub> (1)	Source-drain current (pulsed)	100 4 1/ 0			800	A
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 120 A, V <sub>GS</sub> = 0		00	1.5	V
t <sub>rr</sub> Q <sub>rr</sub>	Reverse recovery time Reverse recovery charge	$I_{SD} = 120 \text{ A,di/dt} = 100 \text{ A/}\mu\text{s}$ $V_{DD} = 35 \text{ V, T}_j = 150 \text{ °C}$		60 110		ns nC
I <sub>RRM</sub>	Reverse recovery current	Figure 18	~	3.5		A
<ol> <li>Pulse width limited by safe operating area</li> <li>Pulsed: Pulse duration = 300 μs, duty cycle 1.5%</li> </ol>						

Electrical characteristics STV200N55F3

## 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

Figure 3. Thermal impedance

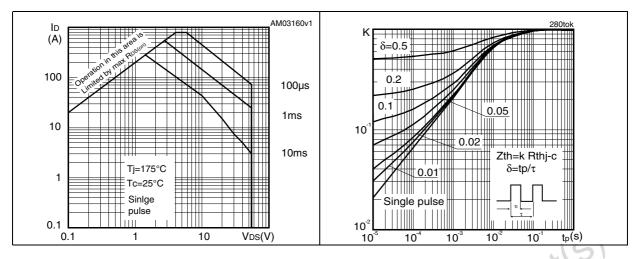


Figure 4. Output characteristics

Figure 5. Transfer characteristics

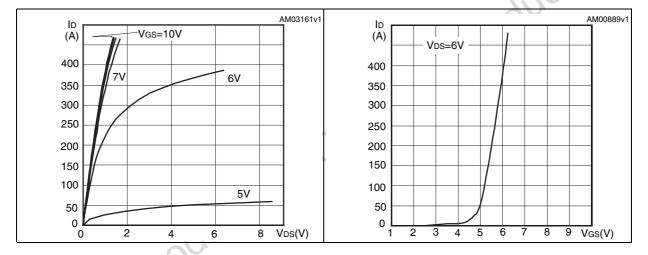
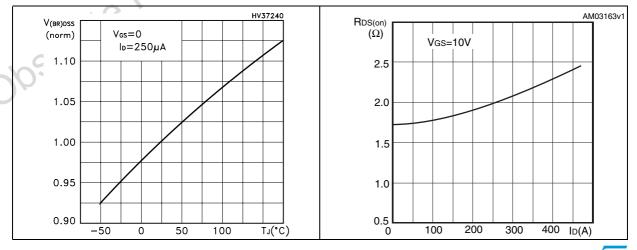


Figure 6. Normalized B<sub>VDSS</sub> vs temperature Figure 7. Static drain-source on resistance



6/12

Figure 8. Gate charge vs gate-source voltage Figure 9. Capacitance variations

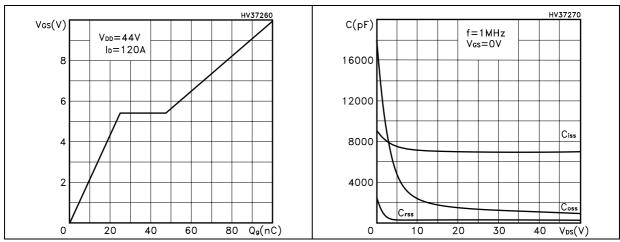


Figure 10. Normalized gate threshold voltage Figure 11. Normalized on resistance vs vs temperature temperature

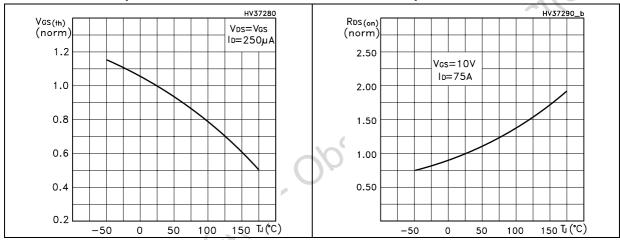
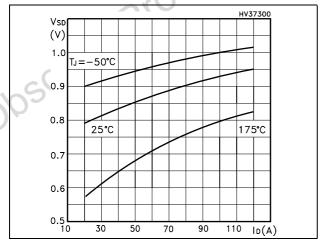


Figure 12. Source-drain diode forward characteristics



Test circuits STV200N55F3

## 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

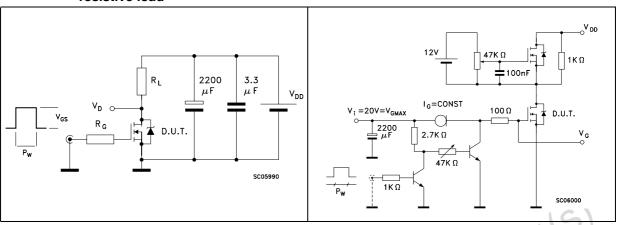


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

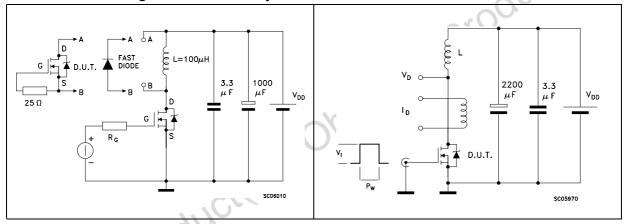
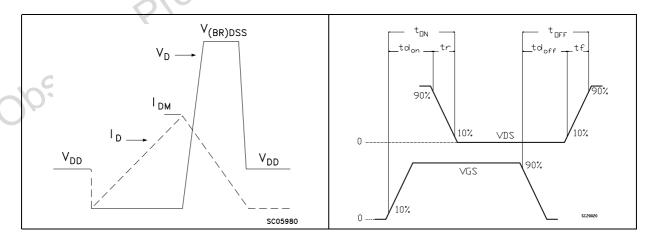


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



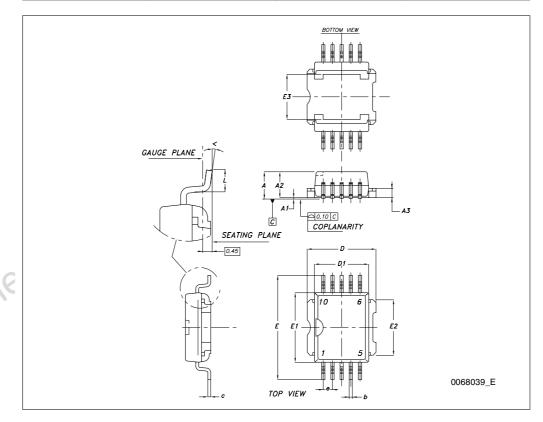
# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

Obsolete Product(s). Obsolete Product(s)

#### PowerSO-10 mechanical data

Dim		mm	
Dim	Min	Тур	Max
A			3.70
A1	0.00		0.10
A2	3.40		3.60
A3	1.25		1.35
b	0.40		0.53
С	0.35		0.55
D	9.40		9.60
D1	7.40		7.60
E	13.80		14.40
E1	9.30		9.50
E2	7.20		7.60
E3	5.90		6.10
е		1.27	
L	0.95		1.65
<	0°		8°



STV200N55F3 Revision history

# 5 Revision history

Table 8. Document revision history

Date	Revision	Changes
05-Mar-2008	1	First release.
10-Nov-2008	2	Document status promoted from preliminary to datasheet.
02-Mar-2009	3	Figure 2 has been updated.



11/12

#### Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2009 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan - Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by STMicroelectronics manufacturer:

Other Similar products are found below:

614233C 648584F MCH3443-TL-E MCH6422-TL-E FW231A-TL-E APT5010JVR NTNS3A92PZT5G IRF100S201 JANTX2N5237

2SK2464-TL-E 2SK3818-DL-E FCA20N60\_F109 FDZ595PZ STD6600NT4G FSS804-TL-E 2SJ277-DL-E 2SK1691-DL-E 2SK2545(Q,T)

405094E 423220D MCH6646-TL-E TPCC8103,L1Q(CM 367-8430-0972-503 VN1206L 424134F 026935X 051075F SBVS138LT1G

614234A 715780A NTNS3166NZT5G 751625C 873612G IRF7380TRHR IPS70R2K0CEAKMA1 RJK60S3DPP-E0#T2 RJK60S5DPK-M0#T0 APT5010JVFR APT12031JFLL APT12040JVR DMN3404LQ-7 NTE6400 JANTX2N6796U JANTX2N6784U

JANTXV2N5416U4 SQM110N05-06L-GE3 SIHF35N60E-GE3 2SK2614(TE16L1,Q) 2N7002KW-FAI APT1201R6BVFRG